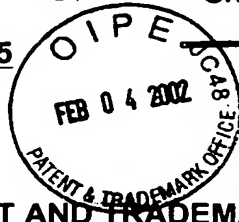


Case No. 00AG11453325



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DIRECTOR, U.S. PATENT AND TRADEMARK OFFICE  
WASHINGTON, DC 20231

In re Application of: **MAGNI ET AL.**

Serial No.: **10/036,335**

Filed: **DECEMBER 26, 2001**

For: **MANUFACTURING METHOD OF AN ELECTRONIC  
DEVICE PACKAGE**

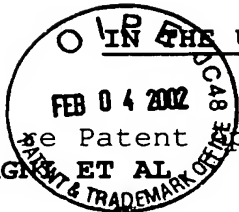
Sir:

Transmitted herewith is an INFORMATION DISCLOSURE STATEMENT in the above-identified application.

1. ☒ This IDS is submitted under 37 C.F.R. § 1.97. No fee is required.
2. ☐ This IDS is submitted under 37 C.F.R. § 1.97(c). Enclosed is a check in the amount of \$ 180.00.
3. ☐ This IDS is submitted under 37 C.F.R. § 1.97(c) and (e). No fee is required.
4. ☐ This IDS is submitted under 37 C.F.R. § 1.97(d) and (e). Enclosed is a check in the amount of \$ 130.00 to cover the petition fee.
5. ☒ **The Commissioner is hereby authorized to charge or credit any discrepancies in fee amounts to Deposit Account No. 01-0484.**

Date: January 15, 2002

CHRISTOPHER F. REGAN  
Reg. No. 34,906



In the Patent Application of:  
**MAGNET ET AL**

COPY OF PAPERS  
ORIGINALLY FILED

Serial No. 10/036,335

Filing Date: **DECEMBER 26, 2001**

For: **MANUFACTURING METHOD OF AN  
ELECTRONIC DEVICE PACKAGE**

**CITATION UNDER 37 CFR §1.97**

Director, U.S. Patent and Trademark Office  
Washington, D.C. 20231

Sir:

Attached is Form PTO-1449 listing several references for consideration in the examination of the above-identified application. A copy of each reference is also enclosed. It is requested that these references be considered by the Examiner and officially made of record in accordance with the provisions of 37 CFR §1.97 and Section 609 of the MPEP.

Respectfully submitted,

CHRISTOPHER F. REGAN

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407/841-2330


Attorney for Applicants

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: **DIRECTOR, U.S. PATENT AND TRADEMARK OFFICE, WASHINGTON, DC 20231**, on this 15<sup>th</sup> day of January, 2002.

COPY OF PAPERS  
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Sheet 1 of 1

<b>INFORMATION DISCLOSURE STATEMENT</b> 	Atty Docket:	00AG11453325
	Serial No.:	10/036,335
	Applicant:	MAGNI ET AL.
	Filing Date:	December 26, 2001
	Group:	

**U.S. PATENT DOCUMENTS**

Examiner Initials		Document Number	Date	Name	Class	Sub Class	Filing Date
	AA	5,275,547	01/4/94	Brown	425	129.1	01/3/92
	AB						
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						
	AK						
	AL						

**FOREIGN PATENT DOCUMENTS**

		Document Number	Date	Country	Class	Sub Class	Translation
	AM	0 813 236 ✓	12/17/97	EP	H01L	21/56	
	AN	87/04973 ✓	08/27/87	WO	B29C	45/26	
	AO						
	AP						

**OTHER ART (Including Author, Title, Date, Pertinent Pages, etc.)**

	AQ	Patent abstracts of Japan, Vol. 1998, No. 08 dated June 30, 1998; publication No. 10075040 published on March 17, 1998, entitled "Method for Manufacturing Resin-Coated Circuit Board"; Applicant: Toshiba Chem Corp.
	AR	

<b>EXAMINER:</b>	<b>DATE CONSIDERED:</b>
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**\*EXAMINER:** Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.